

4-Bit Dual-Supply Non-Inverting Level Translator

Features

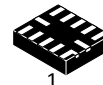
- ## Typical Applications

- ## Important Information

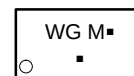
- ESD Protection for All Pins:
HBM (Human Body Model) > 3000 V



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MARKING DIAGRAM



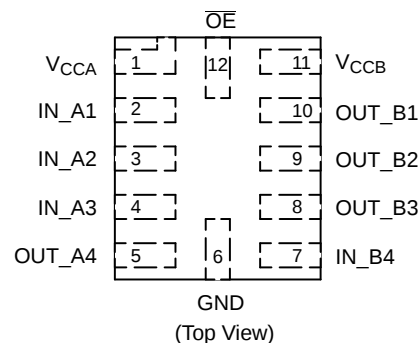
WG = Specific Device Code

M = Date Code

- = Pb-Free Package

(Note: Microdot may be in either location)

PIN ASSIGNMENTS



ORDERING INFORMATION

Device	Package	Shipping [†]
NLSV4T3144MUTAG	UQFN-12 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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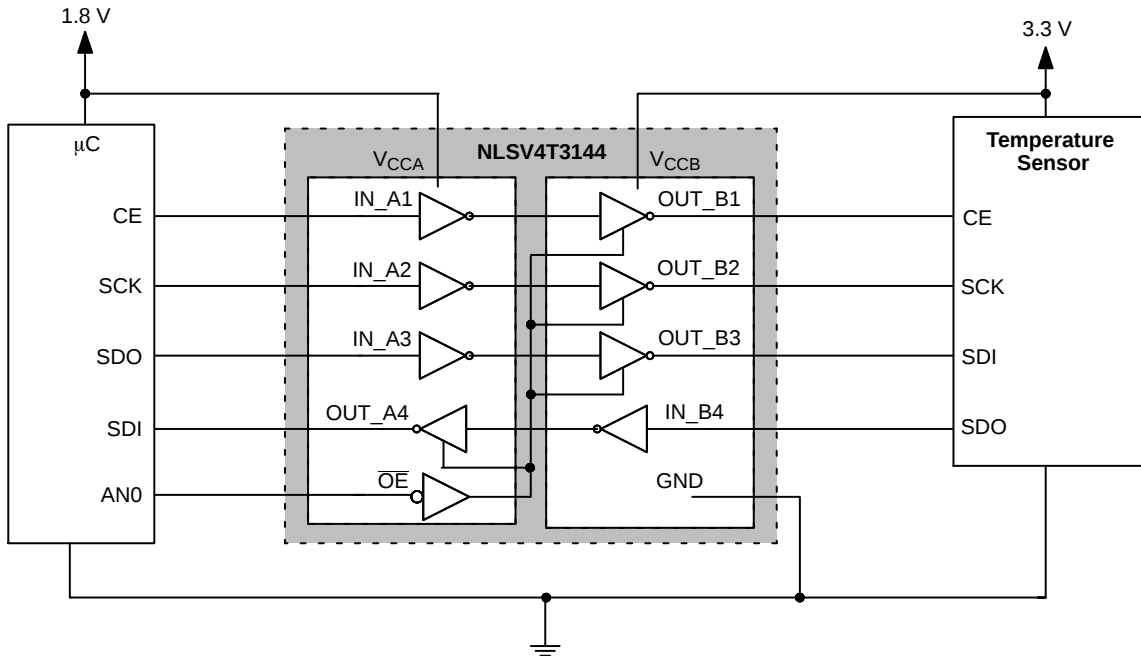


Figure 2. Typical Application: SPI Bus Voltage Translator

PIN NAMES

Pins	Description
V _{CCA}	'A' DC Power Supply
V _{CCB}	'B' DC Power Supply
GND	Ground
IN_A1, IN_A2, IN_A3	Input (Referenced to V _{CCA})
IN_B4	Input (Referenced to V _{CCB})
OUT_B1, OUT_B2, OUT_B3	Output (Referenced to V _{CCB})
OUT_A4	Output (Referenced to V _{CCA})
OE	Output Enable (Referenced to V _{CCA})

TRUTH TABLE

Inputs		Outputs
OE	IN_A1, IN_A2, IN_A3, IN_B4	OUT_B1, OUT_B2, OUT_B3, OUT_A4
H	X	3-State
L	L	L
	H	H

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MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V_{CCA}, V_{CCB}	DC Supply Voltage, $V_{CCA} \leq V_{CCB}$	-0.5 to +5.5		V
V_I	DC Input Voltage IN_{x_n}	-0.5 to +5.5		V
V_C	Control Input $\overline{OE}$	-0.5 to +5.5		V
V_O	DC Output Voltage (Power Down) OUT_{x_n}	-0.5 to +5.5	$V_{CCA} = V_{CCB} = 0$	V
	(Active Mode) OUT_{x_n}	-0.5 to +5.5		
	(Tri-State Mode) OUT_{x_n}	-0.5 to +5.5		
I_{IK}	DC Input Diode Current	-20	$V_I < GND$	mA
I_{OK}	DC Output Diode Current	-50	$V_O < GND$	mA
I_O	DC Output Source/Sink Current	± 50		mA
I_{CCA}, I_{CCB}	DC Supply Current Per Supply Pin	± 100		mA
I_{GND}	DC Ground Current per Ground Pin	± 100		mA
T_{STG}	Storage Temperature	-65 to +150		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CCA}, V_{CCB}	Positive DC Supply Voltage, $V_{CCA} \leq V_{CCB}$	1.6	3.6	V
V_I	Bus Input Voltage	GND	3.6	V
V_C	Control Input $\overline{OE}$	GND	3.6	V
V_{IO}	DC Output Voltage (Power Down) OUT_{x_n}	GND	3.6	V
	(Active Mode) OUT_{x_n}			
	(Tri-State Mode) OUT_{x_n}			
T_A	Operating Temperature Range	-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V_I , from 30% to 70% of V_{CCA} and V_{CCB} ; $V_{CCA} = V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$	0	10	ns

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DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V _{CCA} (V)	V _{CCB} (V)	-40°C to + 85°C		Unit
					Min	Max	
V _{IH} (IN_A1, IN_A2, IN_A3, OE)	Input HIGH Voltage		2.7 – 3.6	≥ V _{CCA}	2.0	–	V
			2.3 – 2.7		1.6	–	
			1.6 – 2.3		0.65 * V _{CCA}	–	
V _{IH} (IN_B4)	Input HIGH Voltage		≤ V _{CCB}	2.7 – 3.6	2.0	–	V
				2.3 – 2.7	1.6	–	
				1.6 – 2.3	0.65 * V _{CCB}	–	
V _{IL} (IN_A1, IN_A2, IN_A3, OE)	Input LOW Voltage		2.7 – 3.6	≥ V _{CCA}	–	0.8	V
			2.3 – 2.7		–	0.7	
			1.6 – 2.3		–	0.35 * V _{CCA}	
V _{IL} (IN_B4)	Input LOW Voltage		≤ V _{CCB}	2.7 – 3.6	–	0.8	V
				2.3 – 2.7	–	0.7	
				1.6 – 2.3	–	0.35 * V _{CCB}	
V _{OH} (OUT_B1, OUT_B2, OUT_B3)	Output HIGH Voltage	I _{OH} = –100 μA; V _I = V _{IH}	≤ V _{CCB}	1.6 – 3.6	V _{CCB} – 0.2	–	V
		I _{OH} = –6 mA; V _I = V _{IH}	1.6	1.6	1.25	–	
			2.3	2.3	2.0	–	
		I _{OH} = –12 mA; V _I = V _{IH}	2.3	2.3	1.8	–	
			2.7	2.7	2.2	–	
		I _{OH} = –18 mA; V _I = V _{IH}	2.3	2.3	1.7	–	
			3.0	3.0	2.4	–	
V _{OH} (OUT_A4)	Output HIGH Voltage	I _{OH} = –100 μA; V _I = V _{IH}	1.6 – 3.6	≥ V _{CCA}	V _{CCA} – 0.2	–	V
		I _{OH} = –6 mA; V _I = V _{IH}	1.6	1.6	1.25	–	
			2.3	2.3	2.0	–	
		I _{OH} = –12 mA; V _I = V _{IH}	2.3	2.3	1.8	–	
			2.7	2.7	2.2	–	
		I _{OH} = –18 mA; V _I = V _{IH}	2.3	2.3	1.7	–	
			3.0	3.0	2.4	–	
V _{OL} (OUT_B1, OUT_B2, OUT_B3)	Output LOW Voltage	I _{OL} = 100 μA; V _I = V _{IH}	≤ V _{CCB}	1.6 – 3.6	–	0.2	V
		I _{OL} = 6 mA; V _I = V _{IH}	1.6	1.6	–	0.3	
		I _{OL} = 12 mA; V _I = V _{IH}	2.3	2.3	–	0.4	
			2.7	2.7	–	0.4	
		I _{OL} = 18 mA; V _I = V _{IH}	2.3	2.3	–	0.6	
			3.0	3.0	–	0.5	
		I _{OL} = 24 mA; V _I = V _{IH}	3.0	3.0	–	0.6	
V _{OL} (OUT_A4)	Output LOW Voltage	I _{OL} = 100 μA; V _I = V _{IH}	1.6 – 3.6	≥ V _{CCA}	–	0.2	V
		I _{OL} = 6 mA; V _I = V _{IH}	1.6	1.6	–	0.3	
		I _{OL} = 12 mA; V _I = V _{IH}	2.3	2.3	–	0.4	
			2.7	2.7	–	0.4	
		I _{OL} = 18 mA; V _I = V _{IH}	2.3	2.3	–	0.6	
			3.0	3.0	–	0.5	
		I _{OL} = 24 mA; V _I = V _{IH}	3.0	3.0	–	0.6	

DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V _{CCA} (V)	V _{CCB} (V)	-40°C to +85°C		Unit
					Min	Max	
I _{IN}	Input Leakage Current	V _{IN_A1} = V _{IN_A2} = V _{IN_A3} = V _{CCA} or GND; V _{IN_B4} = V _{CCB} or GND	≤ V _{CCB}	1.6 – 3.6	-1.0	+1.0	μA
I _{OZ}	I/O Tri – State Output Leakage Current	T _A = 25°C, $\overline{OE}$ = V _{CCA}	≤ V _{CCB}	1.6 – 3.6	–	1.0	μA
I _{CCA}	Quiescent Supply Current	V _{IN_A1} = V _{IN_A2} = V _{IN_A3} = V _{CCA} or GND; V _{IN_B4} = V _{CCB} or GND $\overline{OE}$ = GND, I _O = 0	≤ V _{CCB}	1.6 – 3.6	–	3.0	μA
I _{CCB}	Quiescent Supply Current	V _{IN_A1} = V _{IN_A2} = V _{IN_A3} = V _{CCA} or GND; V _{IN_B4} = V _{CCB} or GND $\overline{OE}$ = GND, I _O = 0	≤ V _{CCB}	1.6 – 3.6	–	3.0	μA
I _{CCA} + I _{CCB}	Quiescent Supply Current	V _{IN_A1} = V _{IN_A2} = V _{IN_A3} = V _{CCA} or GND; V _{IN_B4} = V _{CCB} or GND $\overline{OE}$ = GND, I _O = 0	≤ V _{CCB}	1.6 – 3.6	–	6.0	μA

NOTE: Connect ground before applying supply voltage V_{CCA} or V_{CCB}. This device is designed with the feature that the power-up sequence of V_{CCA} and V_{CCB} will not damage the IC.

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V _{CCA} (V)	-40°C to +85°C						Unit
			V _{CCB} (V)						
			3.6		2.8		1.6		
			Min	Max	Min	Max	Min	Max	
t _{PLH} , t _{PHL}	Propagation Delay,	3.6		3					ns
	Input to Output	2.8		3.1		3.3			
	1.6		4.3		4.5		6.1		
t _{PZH} , t _{PZL}	Output Enable, OE to Output	3.6		8.7					ns
		2.8		10.3		10.7			
	1.6		17.2		18		20		
t _{PHZ} , t _{PLZ}	Output Disable, OE to Output	3.6		7.8					ns
		2.8		8.2		8.4			
	1.6		9.5		9.8		10.5		
t _{OSHL} , t _{OSLH}	Output to Output Skew	3.6		0.25					ns
		2.8		0.25		0.25			
	1.6		0.25		0.25		0.25		

NOTE: Propagation delays defined per Figure 3.

CAPACITANCE

Symbol	Parameter	Test Conditions	Typ (Note 1)	Unit
C _I	Control Pin ($\overline{OE}$) Input Capacitance	V _{CCA} = V _{CCB} = 3.3 V, V _I = 0 V or V _{CCA/B}	3.5	pF
C _{IN}	Input Pin Capacitance	V _{CCA} = V _{CCB} = 3.3 V, V _I = 0 V or V _{CCA/B}	5.0	pF
C _{OUT}	Output Pin Capacitance	V _{CCA} = V _{CCB} = 3.3 V, V _I = 0 V or V _{CCA/B}	5.0	pF
C _{PD}	Power Dissipation Capacitance	V _{CCA} = V _{CC2} = 3.3 V, V _I = 0 V or 3.3 V, f = 10 MHz	10	pF

1. Typical values are at T_A = +25°C.

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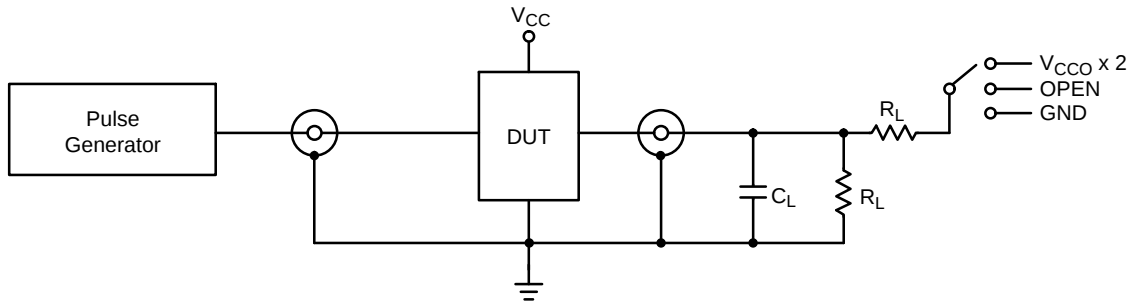
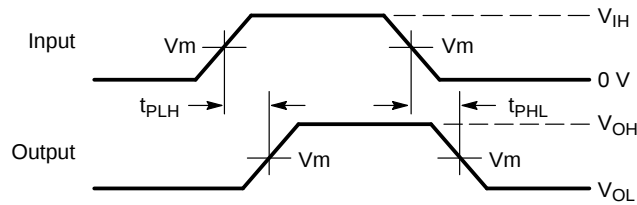


Figure 3. AC (Propagation Delay) Test Circuit

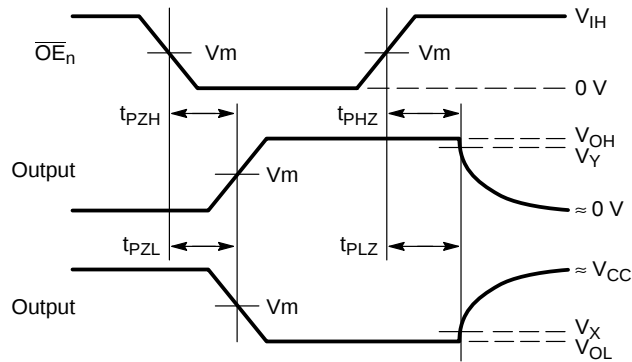
Test	Switch
t_{PLH} , t_{PHL}	OPEN
t_{PLZ} , t_{PZL}	$V_{CCO} \times 2$ at $V_{CCO} = 3.0\text{ V} - 3.6\text{ V}$, $2.3\text{ V} - 2.7\text{ V}$, $1.65\text{ V} - 1.95\text{ V}$, $1.4\text{ V} - 1.6\text{ V}$
t_{PHZ} , t_{PZH}	GND

$C_L = 15\text{ pF}$ or equivalent (includes probe and jig capacitance)
 $R_L = 2\text{ k}\Omega$ or equivalent
 Z_{OUT} of pulse generator = $50\text{ }\Omega$
 V_{CCO} is the supply voltage referenced to by the output being tested



Waveform 1 - Propagation Delays

$t_R = t_F = 2.0\text{ ns}$, 10% to 90%; $f = 1\text{ MHz}$; $t_W = 500\text{ ns}$



Waveform 2 - Output Enable and Disable Times

$t_R = t_F = 2.0\text{ ns}$, 10% to 90%; $f = 1\text{ MHz}$; $t_W = 500\text{ ns}$

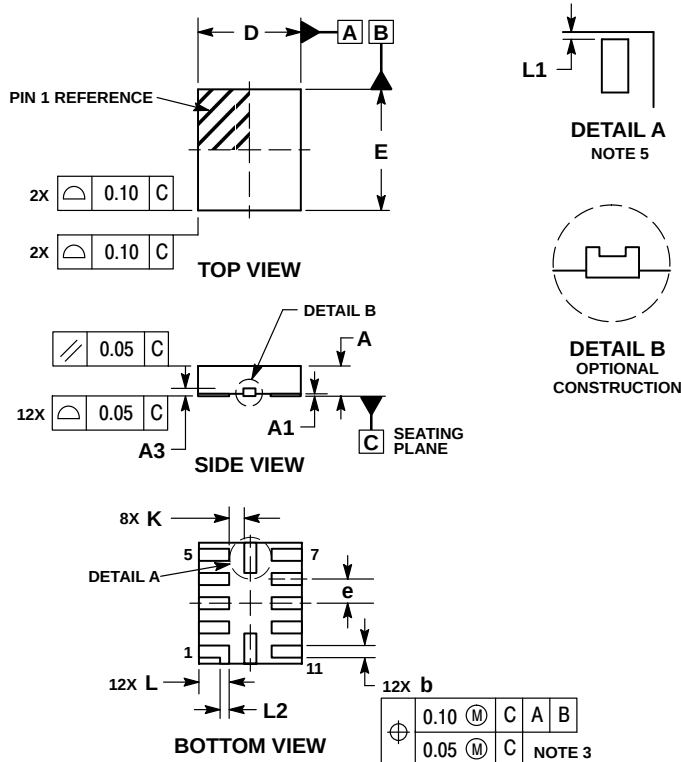
Figure 4. AC (Propagation Delay) Test Circuit Waveforms

Symbol	Input Pin Output Pin
V_m	$V_{CCX}/2$
V_X	$V_{OL} \times 0.1$
V_Y	$V_{OH} \times 0.9$

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PACKAGE DIMENSIONS

UQFN12 1.7x2.0, 0.4P
CASE 523AE
ISSUE A

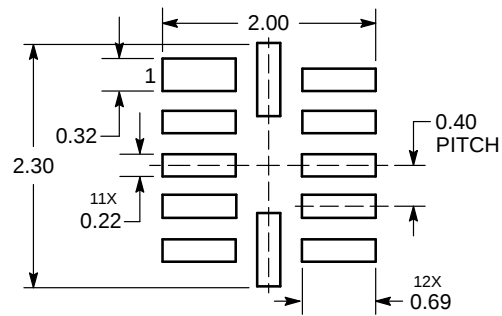


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH 0.03 MAX ON BOTTOM SURFACE OF TERMINALS.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127	REF
b	0.15	0.25
D	1.70	BSC
E	2.00	BSC
e	0.40	BSC
K	0.20	----
L	0.45	0.55
L1	0.00	0.03
L2	0.15	REF

MOUNTING FOOTPRINT SOLDSMART DEFINED



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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